

maXTouch 640-node Touchscreen Controller Product Brief

Description

The mXT640U uses a unique charge-transfer acquisition engine to implement Microchip's patented capacitive sensing method. Coupled with a state-of-the-art CPU, the entire touchscreen sensing solution can measure, classify and track a number of individual finger touches with a high degree of accuracy in the shortest response time. The mXT640U allows for both mutual and self capacitance measurements, with the self capacitance measurements being used to augment the mutual capacitance measurements to produce reliable touch information.

maXTouch[®] Adaptive Sensing Touchscreen Technology

- Up to 32 X (transmit) lines and 20 Y (receive) lines
- A maximum of 640 nodes can be allocated to the touchscreen
- Touchscreen size 8.17 inches (16:10 aspect ratio), assuming a sensor electrode pitch of 5.5 mm. Other sizes may be possible with different electrode pitches and appropriate sensor material
- Multiple touch support with up to 16 concurrent touches tracked in real time
- Dual-boot OS support for $\mathsf{Microsoft}^{\texttt{®}}$ $\mathsf{Windows}^{\texttt{B}}$ and Android

Touch Sensor Technology

- Discrete/out-cell support including glass and PET filmbased sensors
- On-cell/touch-on display support including TFT, IPS and OLED
- · Synchronization with display refresh timing capability
- Support for standard (for example, Diamond) and proprietary sensor patterns (review of designs by Microchip recommended)

Front Panel Material

- Works with PET or glass, including curved profiles (configuration and stack-up to be approved by Microchip)
- Glass 0.4 mm to 4.5 mm, dependent on screen size, touch size and stack-up
- Plastic 0.2 mm to 2.2 mm, dependent on screen size, touch size and stack-up

Touch Performance

- Moisture/Water Compensation
 - No false touch with condensation or water drop up to 22 mm diameter
 - One-finger tracking with condensation or water drop up to 22 mm diameter

- Glove Support
 - Multiple-finger glove touches up to 1.5 mm thickness (subject to stack-up design)
 - Single-finger glove touch up to 5 mm thickness (subject to stack-up design)
- Mutual capacitance and self capacitance
 measurements supported for robust touch detection
- Noise suppression technology to combat ambient, charger noise, and power-line noise
 - Up to 240 Vpp between 1 Hz and 1 kHz sinusoidal waveform
 - Up to 20 Vpp between 1 kHz and 1 MHz sinusoidal waveform
- Stylus Support
 - Supports passive stylus with 1 mm contact diameter, subject to configuration, stack up, and sensor design
- Scan Speed
 - Up to 250 Hz one finger reporting rate, subject to configuration
 - Typical report rate for 10 touches ≥100 Hz (subject to configuration)
 - Initial touch latency <20 ms for first touch from idle, subject to configuration
 - Configurable to allow for power and speed optimization

On-chip Gestures

• Supports wake up/unlock gestures, including symbol recognition

Keys

- Up to 32 nodes can be allocated as mutual capacitance sensor keys (subject to other configurations)
- Support for 3 Generic Keys in addition to the touchscreen array (subject to other configurations)
- Adjacent Key Suppression (AKS) technology is supported for false key touch prevention

Enhanced Algorithms

- Lens bending algorithms to remove display noise
- · Touch suppression algorithms to remove unintentional large touches, such as palm
- · Palm Recovery Algorithm for quick restoration to normal state

Product Data Store Area

• Up to 32 bytes of user-defined data can be stored during production

Power Saving

- · Programmable timeout for automatic transition from active to idle states
- · Pipelined analog sensing detection and digital processing to optimize system power efficiency

Application Interfaces

- I²C-compatible slave mode: Standard/Fast mode 400 kHz, Fast-mode Plus 1 MHz, High-speed mode up to 3.4 MHz
- HID-I²C interface for Microsoft[®] Windows[®] 8.x and later versions
- · Interrupt to indicate when a message is available
- · SPI Debug Interface to read the real-time raw data for tuning and debugging purposes

Power Supply

- Digital (Vdd) 3.3 V nominal
- Digital I/O (VddIO) 3.3 V nominal
- Analog (AVdd) 3.3 V nominal
- · High voltage internal X line drive (XVdd) 6.6 V with internal voltage pump
- · High voltage internal X line drive (XVdd) 9.9 V with internal voltage pump

Packages

- 88-ball UFBGA 6 × 6 × 0.6 mm, 0.5 mm pitch
- 88-ball X1FBGA 6 × 6 × 0.45 mm, 0.5 mm pitch

Operating Temperature

• -40°C to +85°C

PIN CONFIGURATION

88-ball UFBGA/X1FBGA

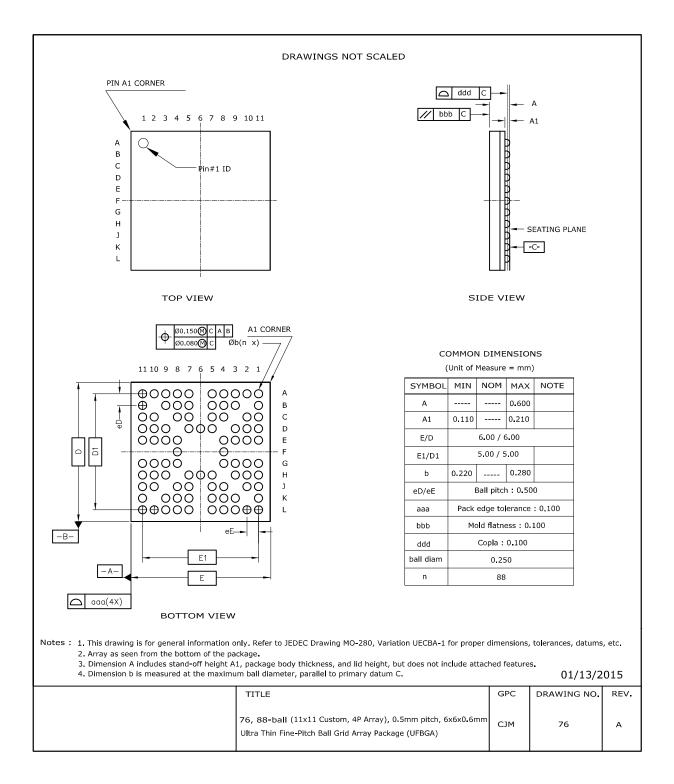
	1	2	3	4	5	6	7	8	9	10	11
A	AVDD	O DS0	О У18	О ¥16	О У14		О Ү8	О Үб	O Y4	O Y2	O Y0
в	О X18		О У19	О Y17	О У15		О У7	O Y5	О _{Y3}		AVDD
с	O x20	О х19		GND	О У13		О Ү9	O Y1		O x0	O X1
D	О X22	O X21	O X17		О У12	O Y11	О У10		GND) x2	О хз
Е	О _{Х24}	О х23	О x25	О _{Х26}				О х7	О х6	O X4	О х5
F) x27				О х8			
G	О ×30	О _{X31}) X29	О _{X28}				О Х9	О х10	O X12	O X11
н	RESV	O RESV	O EXTCAP1		GPIO2 DBG_CLK	O TEST			GND	O X14	O X13
J	O EXTCAP0	O EXTCAP3			GPIO1 DBG_SS DBG2_FRAME		ADDSEL DBG2_DATA0	GPIO6 DBG_DATA DBG2_DATA5		О X16	О x15
к	O EXTCAP2				GPIO0 DBG2_CLK		I2CMODE DBG2_DATA2	GPI05	GKEYY2		GKEYX0
L	O XVDD	O VDD		SCL	O SDA		SYNC GPIO3 DBG2_DATA1	NOISE_IN GPIO4 DBG2_DATA3	GKEYY1	GKEYYO	O XVDD

Top View

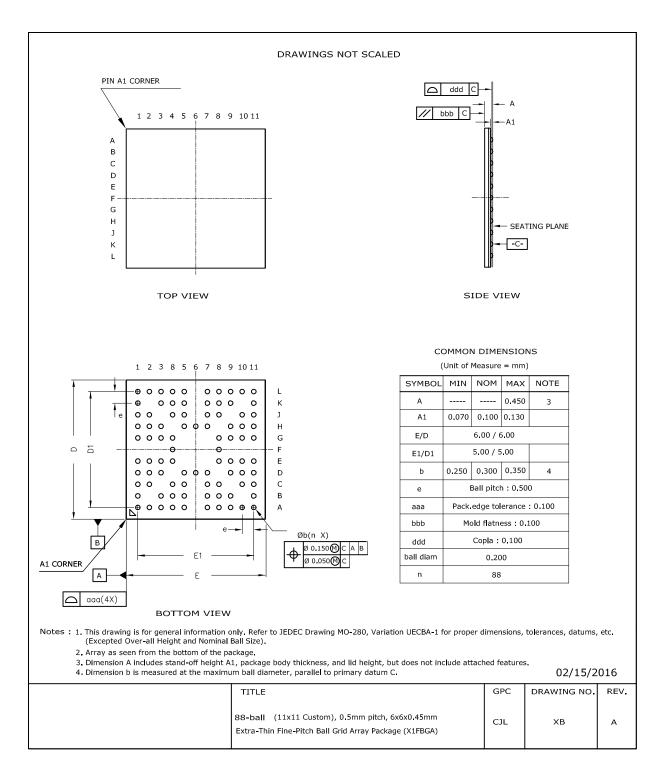
1.0 PACKAGING INFORMATION

The following sections give the technical details of the packages for the device.

1.1 88-ball UFBGA 6 × 6 × 0.6 mm



1.2 88-ball X1FBGA 6 × 6 × 0.45 mm



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APPENDIX A: REVISION HISTORY

Revision A (September 2017)

Initial edition for firmware revision 1.1 - Release

PRODUCT IDENTIFICATION SYSTEM

The table below gives details on the product identification system for maXTouch devices. See "Orderable Part Numbers" below for example part numbers for the mXT640U.

To order or obtain information, for example on pricing or delivery, refer to the factory or the listed sales office.

Device	Package	Temperati Range	ure Sample Type	Tape and Reel Option	Pattern		
Device:	Bas	e device n	ame				
Package:	А	=	QFP (Plastic	Quad Flatpack)		
	CCL	J =	UFBGA (Ultra	a Thin Fine-pitc	h Ball Grid Array)		
	C2L		UFBGA (Ultra	a Thin Fine-pitc	h Ball Grid Array)		
	NHU	-	UFBGA (Ultra	a Thin Fine-pitc	h Ball Grid Array)		
	C4L		,	•	tch Ball Grid Array)		
	MAU	-			it No Lead Sawn)		
	MAS	5U =			it No Lead Sawn)		
	UU	=	WLCSP (Waf	er Level Chip S	Scale Package)		
Temperature Range:	Blar	nk =	–40°C to +85	°C (Grade 3)			
	Т	=	–40°C to +85	°C (Grade 3)			
	В	=	–40°C to +10	5°C (Grade 2)			
Sample Type:	Blar	nk =	Release Sam				
	ES	=	Pre-release (Engineering) Sample				
Tape and Reel Option:	Blar	nk =	Standard Packaging (Tube or Tray)				
1 - 1	R	=	Tape and Reel (I)				
Pattern:		, SQTP, C nk Otherw					
identifier is	used for or able Part N	dering pur	poses and is n	ot printed on th	er description. This e device package. chip Sales Office for		

Orderable Part Numbers

Orderable Part Number	Firmware Revision	Description		
ATMXT640U-CCU023 (Supplied in trays)	1.1.AA	88-ball UFBGA 6 × 6 × 0.6 mm, RoHS compliant Industrial grade sample; not suitable for automotive		
ATMXT640U-CCUR023 (Supplied in tape and reel)		characterization		
ATMXT640U-C4U023 (Supplied in trays)	1.1.AA	88-ball X1FBGA 6 × 6 × 0.45 mm, RoHS compliant Industrial grade sample; not suitable for automotive		
ATMXT640U-C4UR023 (Supplied in tape and reel)		characterization		

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